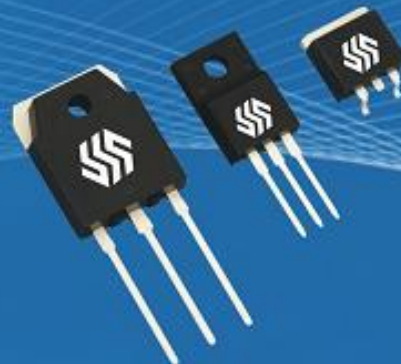




SUPER-SEMI



## SUPER-MOSFET

Super Junction Metal Oxide Semiconductor Field Effect Transistor

500V Super Junction Power Transistor  
SS\*50R140S

Rev. 1.2  
May.2018

[www.supersemi.com.cn](http://www.supersemi.com.cn)

## SJ-FET

# SSF50R140S/SSP50R140S/SSW50R140S/SSA50R140S

## 500V N-Channel MOSFET

### Description

SJ-FET is new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

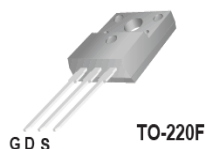
This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy.

SJ-FET is suitable for various AC/DC power conversion in switching mode operation for higher efficiency.

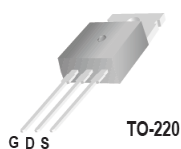
### Features

- Multi-Epi process SJ-FET
- 550V @T<sub>J</sub> = 150 °C
- Typ. R<sub>DS(on)</sub> = 0.12Ω
- Ultra Low Gate Charge (typ. Q<sub>g</sub> = 30nC)
- 100% avalanche tested

SSF50R140S



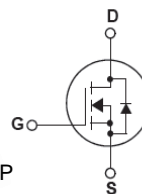
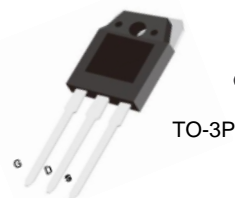
SSP50R140S



SSW50R140S



SSA50R140S



### Absolute Maximum Ratings

Symbol	Parameter	SSP_W_A50R140S	SSF50R140S	Unit
V <sub>DSS</sub>	Drain-Source Voltage	500		V
I <sub>D</sub>	Drain Current -Continuous (TC = 25°C) -Continuous (TC = 100°C)	24* 15*		A
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)	70		A
V <sub>GSS</sub>	Gate-Source voltage	±30		V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	485		mJ
I <sub>AR</sub>	Avalanche Current (Note 1)	3.5		A
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)	1		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	15		V/ns
dV <sub>ds</sub> /dt	Drain Source voltage slope (V <sub>ds</sub> =400V)	50		V/ns
P <sub>D</sub>	Power Dissipation (TC = 25°C)	151	35	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150		°C
T <sub>L</sub>	Max. Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds	300		°C

\* Drain current limited by maximum junction temperature. Maximum duty cycle D=0.75.

### Thermal Characteristics

Symbol	Parameter	SSP_W_A50R140S	SSF50R140S	Unit
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	0.83	3.7	°C/W
R <sub>θCS</sub>	Thermal Resistance, Case-to-Sink Typ.	0.5	-	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	62	80	°C/W



# Electrical Characteristics TC = 25°C unless otherwise noted

SSF50R140S/SSP50R140S/SSW50R140S/SSA50R140S 500V N-Channel MOSFET

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA, T <sub>J</sub> = 25°C	500	-	-	V
		V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA, T <sub>J</sub> = 150°C	-	550	-	V
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250μA, Referenced to 25°C	-	0.6	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 500V, V <sub>GS</sub> = 0V -T <sub>J</sub> = 150°C	-	- 10	1 -	μA μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30V, V <sub>DS</sub> = 0V	-	-	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30V, V <sub>DS</sub> = 0V	-	-	-100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2.5	-	4.5	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 12A	-	0.12	0.14	Ω
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 40V, I <sub>D</sub> = 20A	-	19	-	S
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1.0MHz	-	1440	-	pF
C <sub>oss</sub>	Output Capacitance		-	370	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	11	-	pF
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 400V, I <sub>D</sub> = 12A R <sub>G</sub> = 20Ω (Note 4)	-	15	-	ns
t <sub>r</sub>	Turn-On Rise Time		-	11	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	110	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	9	-	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 400V, I <sub>D</sub> = 20A V <sub>GS</sub> = 10V (Note 4)	-	30	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	10	-	nC
Q <sub>gd</sub>	Gate-Drain Charge		-	9	-	nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current		-	-	24	A
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		-	-	70	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 12A	-	0.9	1.5	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	-	500	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> /dt = 100A/μs	-	6	-	μC

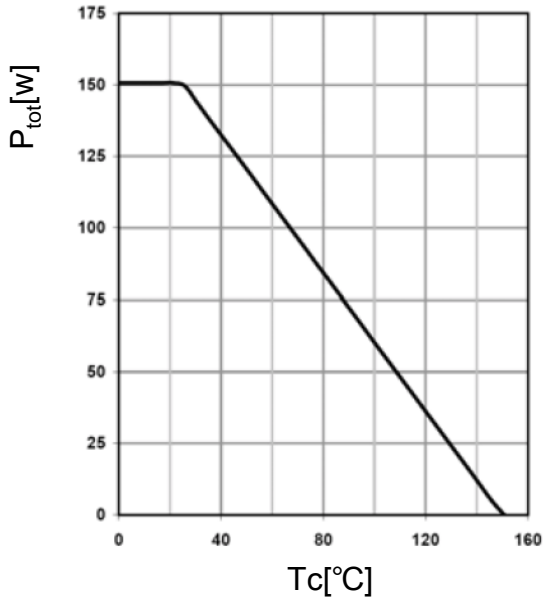
**NOTES:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I<sub>AS</sub>=3.5A, V<sub>DD</sub>=50V, Starting T<sub>J</sub>=25 °C
3. I<sub>SD</sub>≤I<sub>D</sub>, di/dt ≤ 200A/μs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25 °C
4. Essentially Independent of Operating Temperature Typical Characteristics

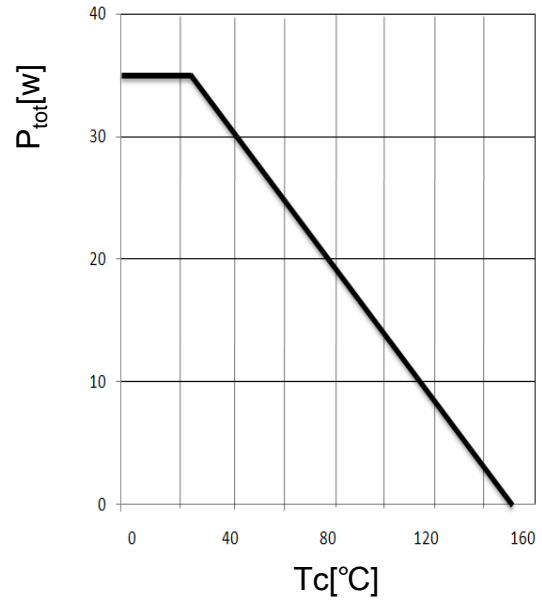


# Typical Performance Characteristics

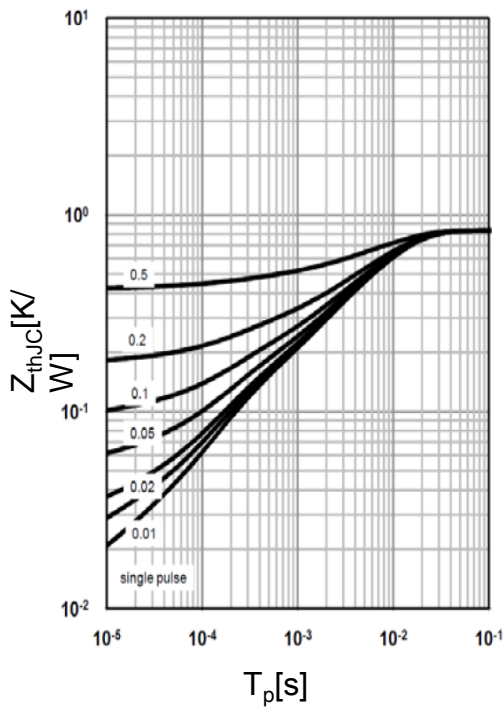
Power dissipation  
TO-220, TO-247, TO-3P



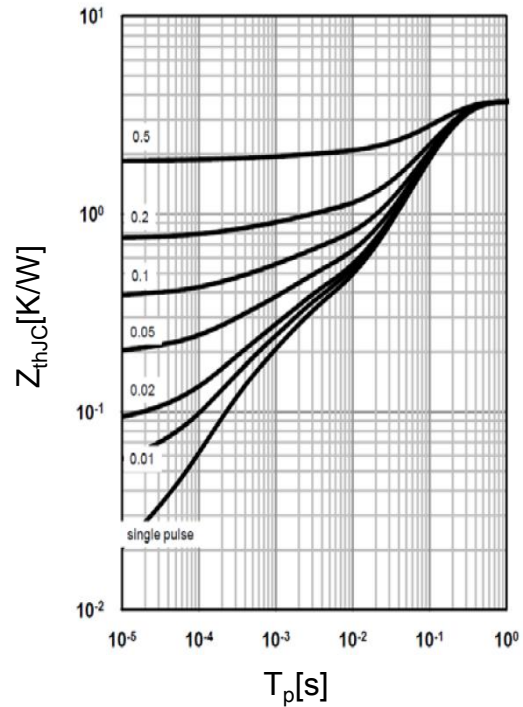
Power dissipation  
TO-220F



Max. transient thermal impedance  
TO-220, TO-247, TO-3P



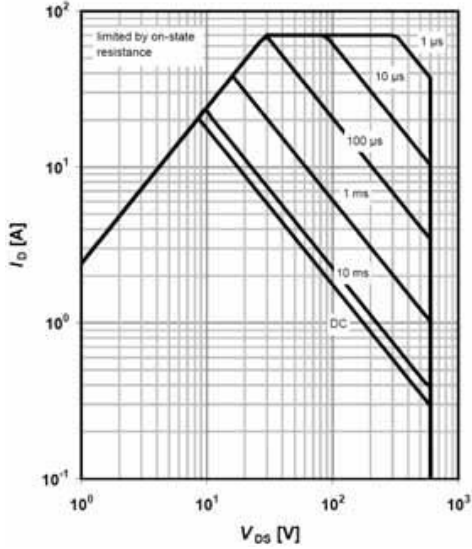
Max. transient thermal impedance  
TO-220F





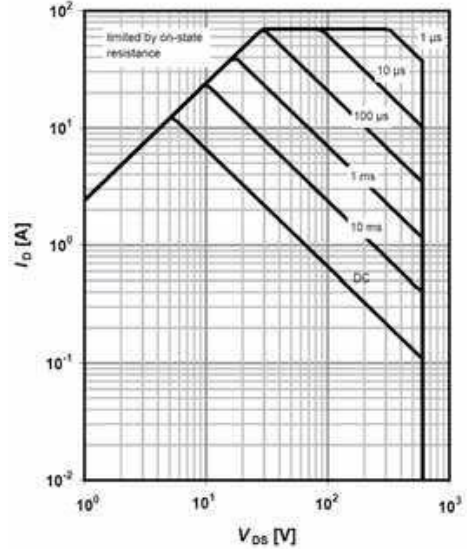
# Typical Performance Characteristics

Safe operating area  $TC=25\text{ }^{\circ}\text{C}$   
TO-220, TO-247, TO-3P

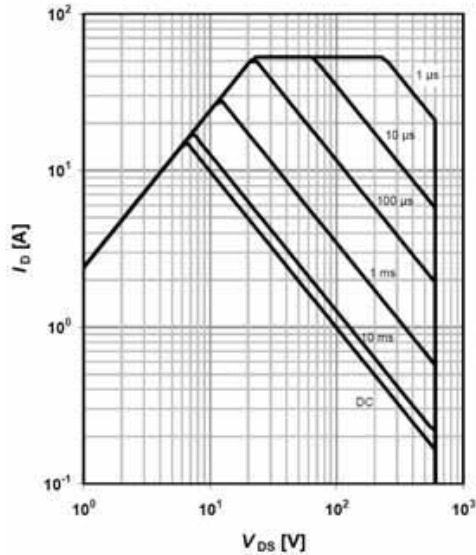


$$I_D=f(V_{DS}); T_C=25\text{ }^{\circ}\text{C}; V_{GS} > 7\text{V}; D=0; \text{parameter } t_p$$

Safe operating area  $TC=25\text{ }^{\circ}\text{C}$   
TO-220F

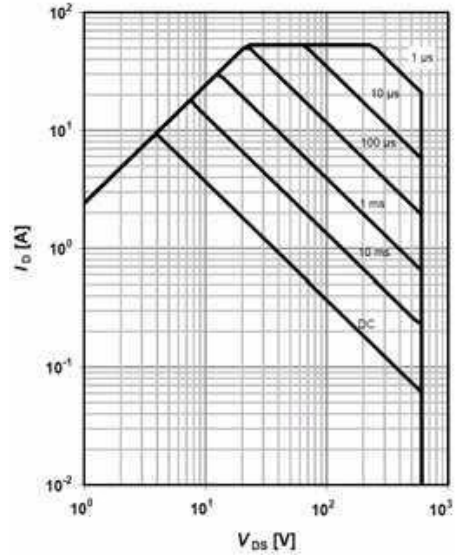


Safe operating area  $TC=80\text{ }^{\circ}\text{C}$   
TO-220, TO-247, TO-3P



$$I_D=f(V_{DS}); T_C=80\text{ }^{\circ}\text{C}; V_{GS} > 7\text{V}; D=0; \text{parameter } t_p$$

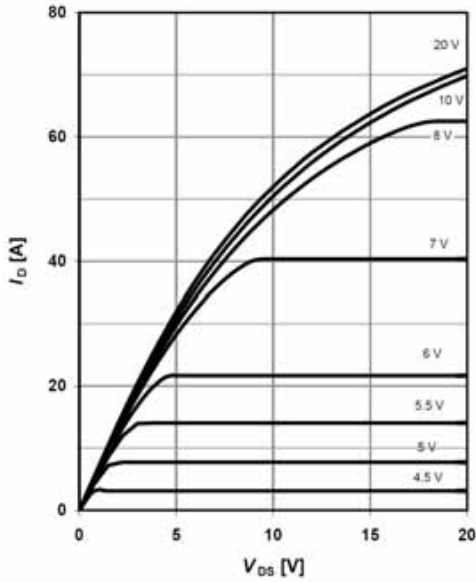
Safe operating area  $TC=80\text{ }^{\circ}\text{C}$   
TO-220F





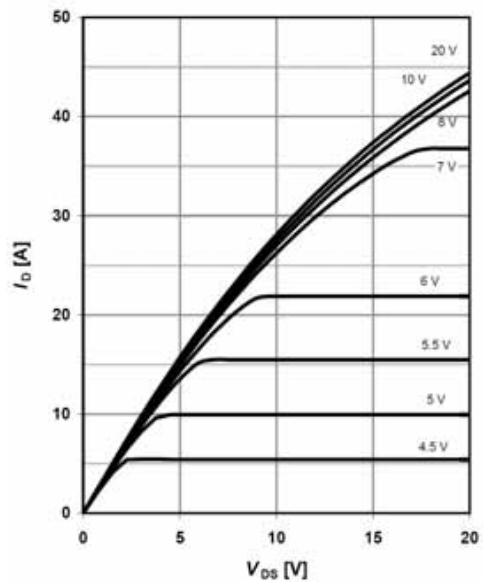
# Typical Performance Characteristics

Typ. output characteristics  
 $T_j=25\text{ }^\circ\text{C}$



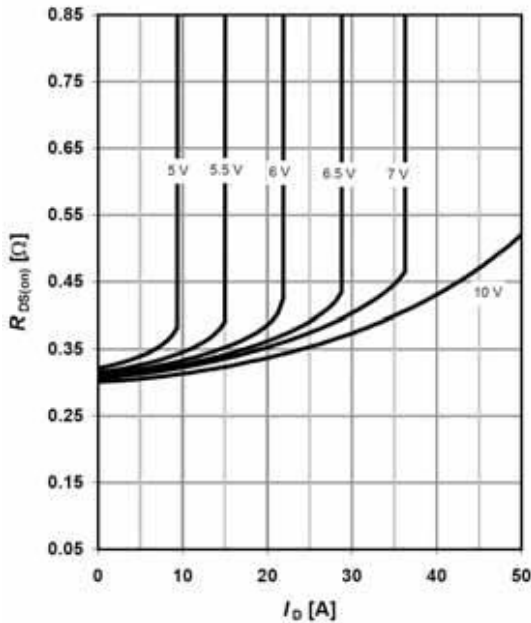
$I_D=f(V_{DS}); T_j=25\text{ }^\circ\text{C}; \text{parameter: } V_{GS}$

Typ. output characteristics  
 $T_j=125\text{ }^\circ\text{C}$



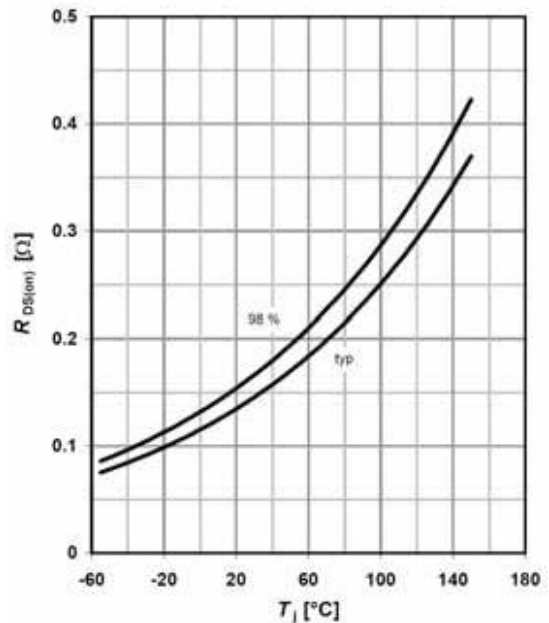
$I_D=f(V_{DS}); T_j=125\text{ }^\circ\text{C}; \text{parameter: } V_{GS}$

Typ. drain-source on-state resistance



$R_{DS(on)}=f(I_D); T_j=125\text{ }^\circ\text{C}; \text{parameter: } V_{GS}$

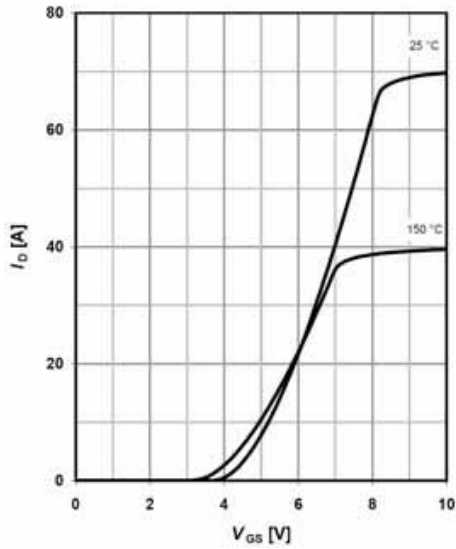
Typ. drain-source on-state resistance



$R_{DS(on)}=f(T_j); I_D=12\text{ A}; V_{GS}=10\text{ V}$

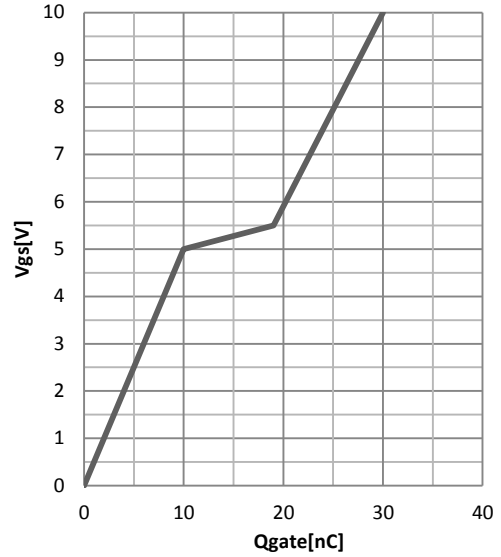
# Typical Performance Characteristics

Typ. transfer characteristics



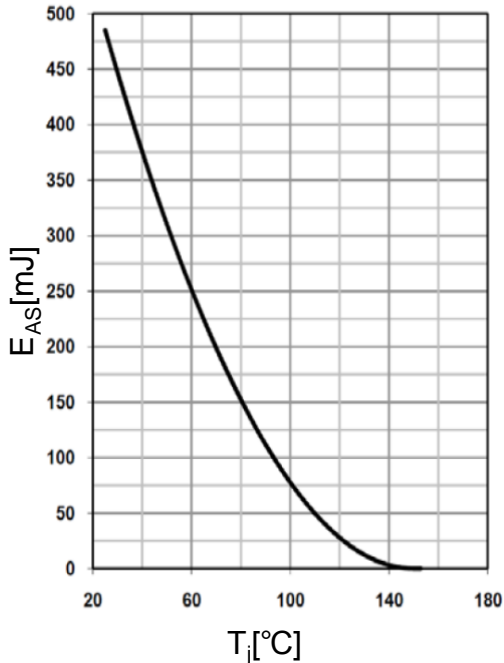
$$I_D = f(V_{GS}); V_{DS} = 40V$$

Typ. gate charge



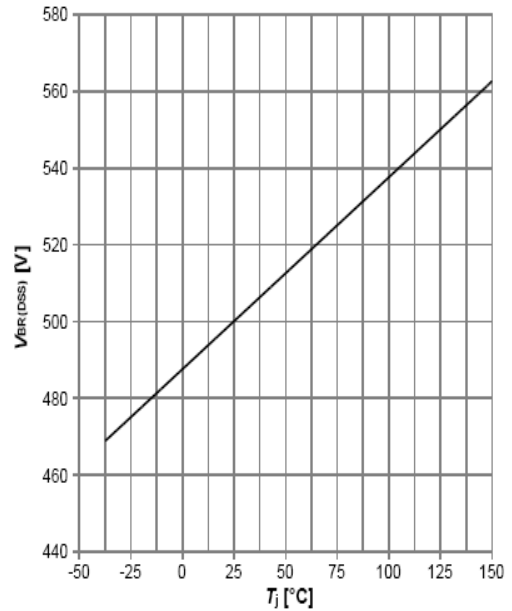
$$V_{GS} = f(Q_g), I_D = 20A \text{ pulsed}$$

Avalanche energy



$$E_{AS} = f(T_j); I_D = 3.5A; V_{DD} = 50V$$

Drain-source breakdown voltage

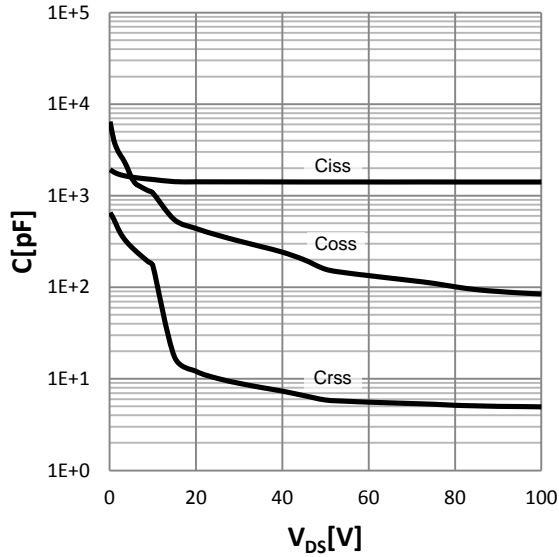


$$V_{BR(DSS)} = f(T_j); I_D = 0.25mA$$



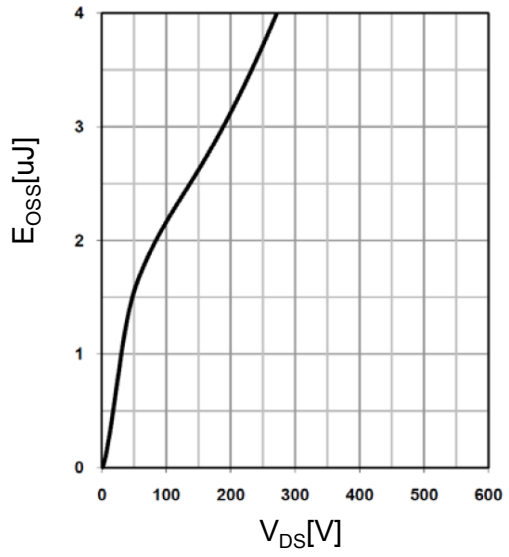
# Typical Performance Characteristics

Typ. capacitances



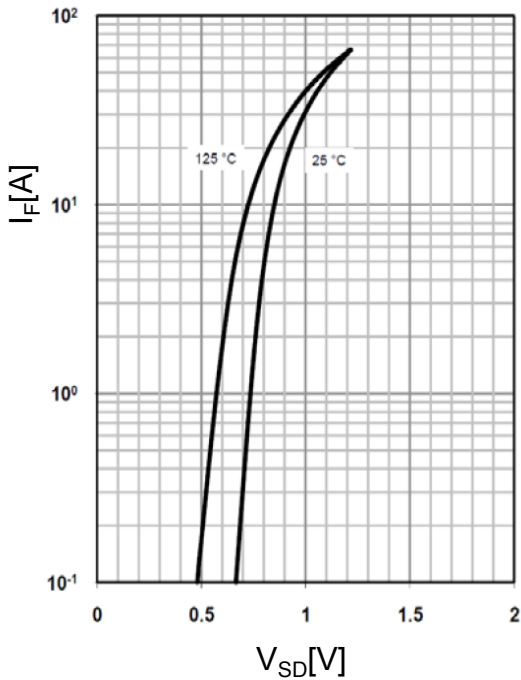
$C=f(V_{DS}); V_{GS}=0\text{ V}; f=1\text{ MHz}$

Typ. Coss stored energy



$E_{OSS}=f(V_{DS})$

Forward characteristics of reverse diode

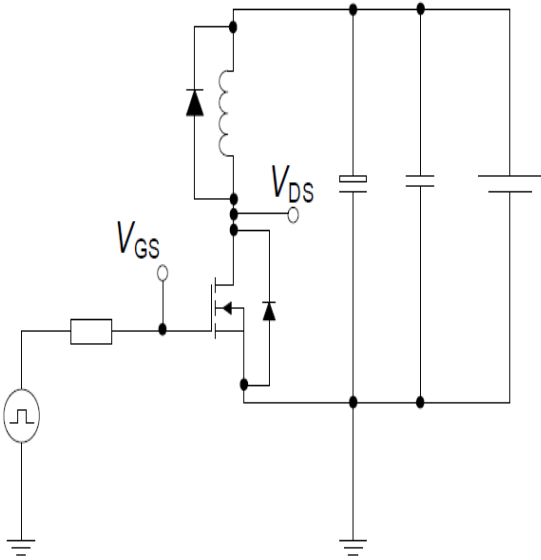


$I_F=f(V_{SD}); \text{parameter: } T_j$

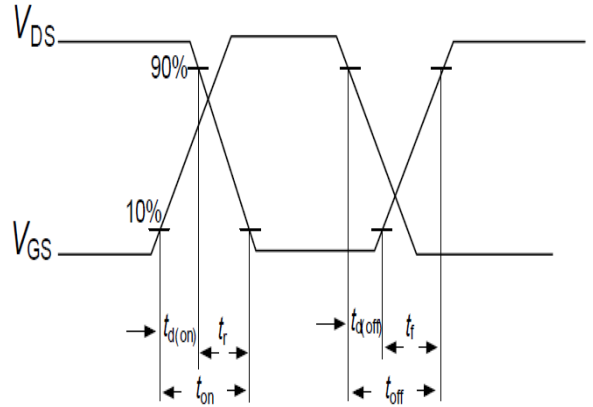


Switching times test circuit and waveform for inductive load

Switching times test circuit for inductive load

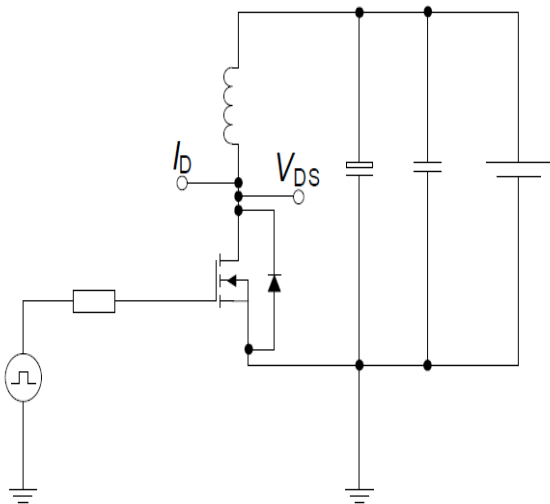


Switching time waveform

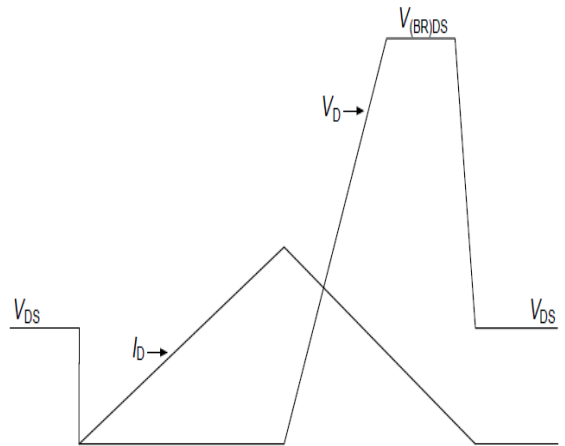


Unclamped inductive load test circuit and waveform

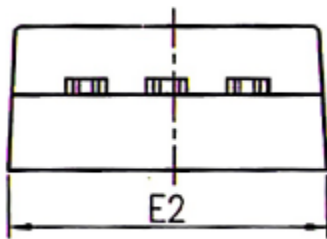
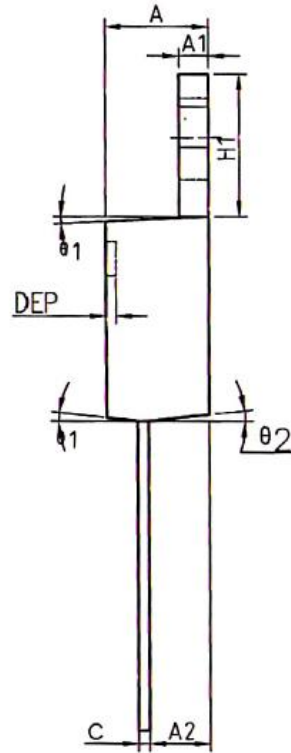
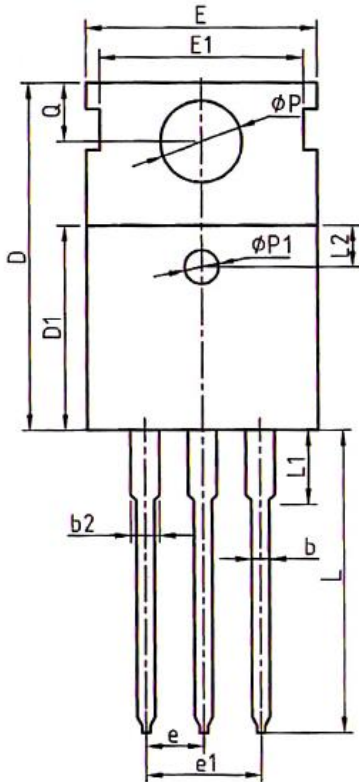
Unclamped inductive load test circuit



Unclamped inductive waveform

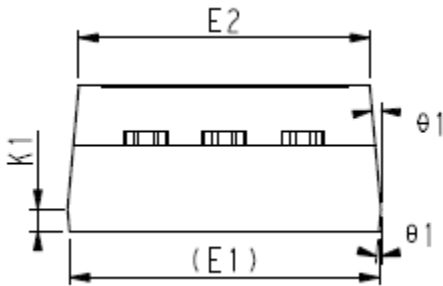
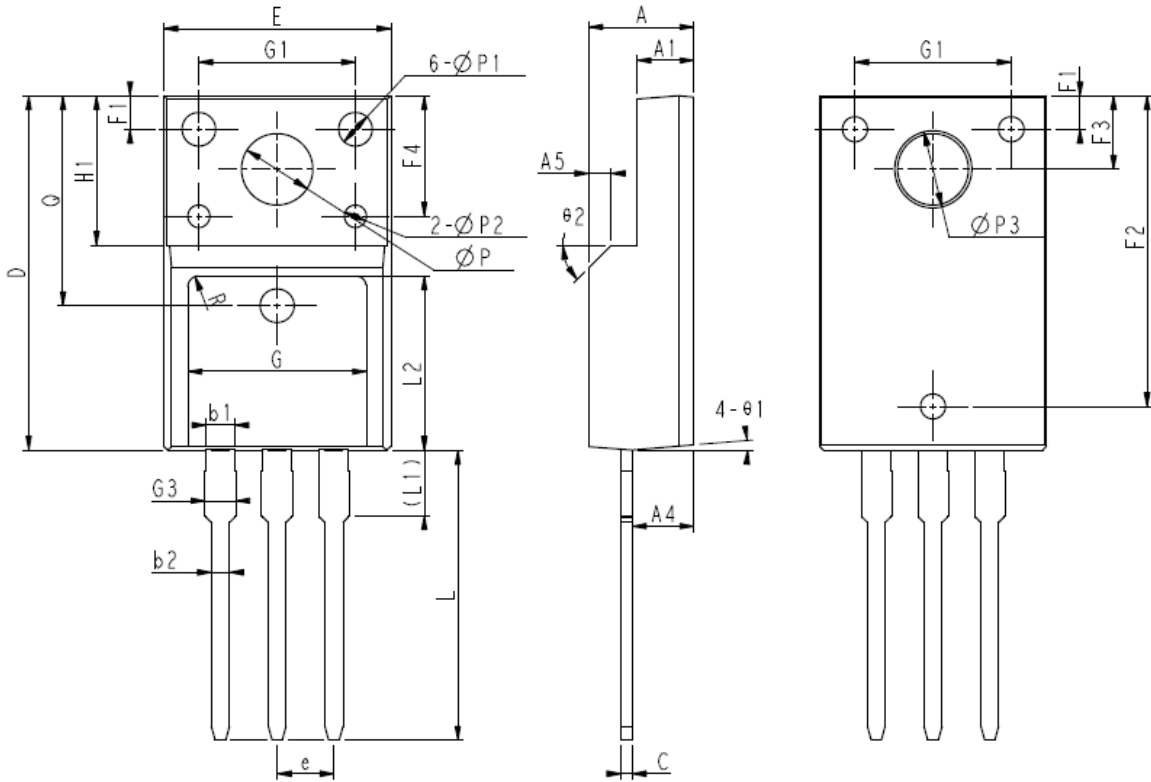






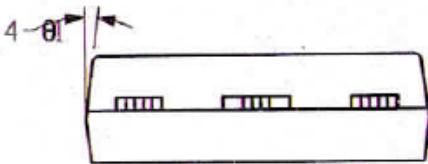
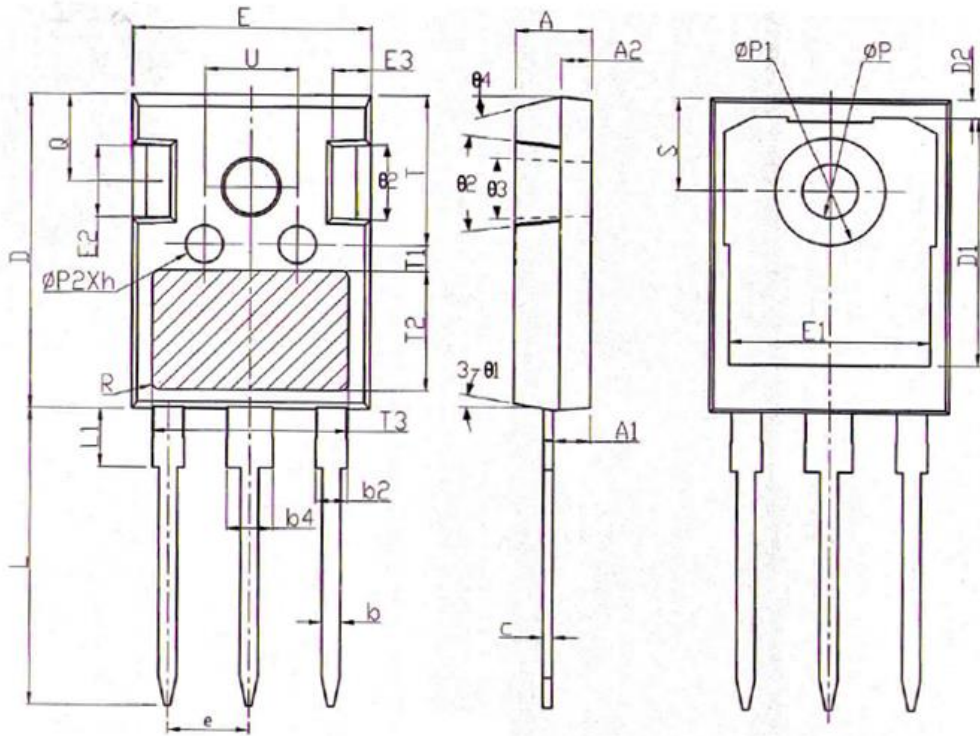
### COMMON DIMENSIONS

SYMBOL	MM		
	MIN	NDM	MAX
A	4.40	4.57	4.70
A1	1.27	1.30	1.37
A2	2.35	2.40	2.50
b	0.77	0.80	0.90
b2	1.17	1.27	1.36
c	0.48	0.50	0.56
D	15.40	15.60	15.80
D1	9.00	9.10	9.20
DEP	0.05	0.10	0.20
E	9.80	10.00	10.20
E1	-	8.70	-
E2	9.80	10.00	10.20
$\phi P1$	1.40	1.50	1.60
e	2.54BSC		
e1	5.08BSC		
H1	6.40	6.50	6.60
L	12.75	13.50	13.65
L1	-	3.10	3.30
L2	2.50REF		
$\phi P$	3.50	3.60	3.63
Q	2.73	2.80	2.87
$\theta 1$	5°	7°	9°
$\theta 2$	1°	3°	5°
$\theta 3$	1°	3°	5°



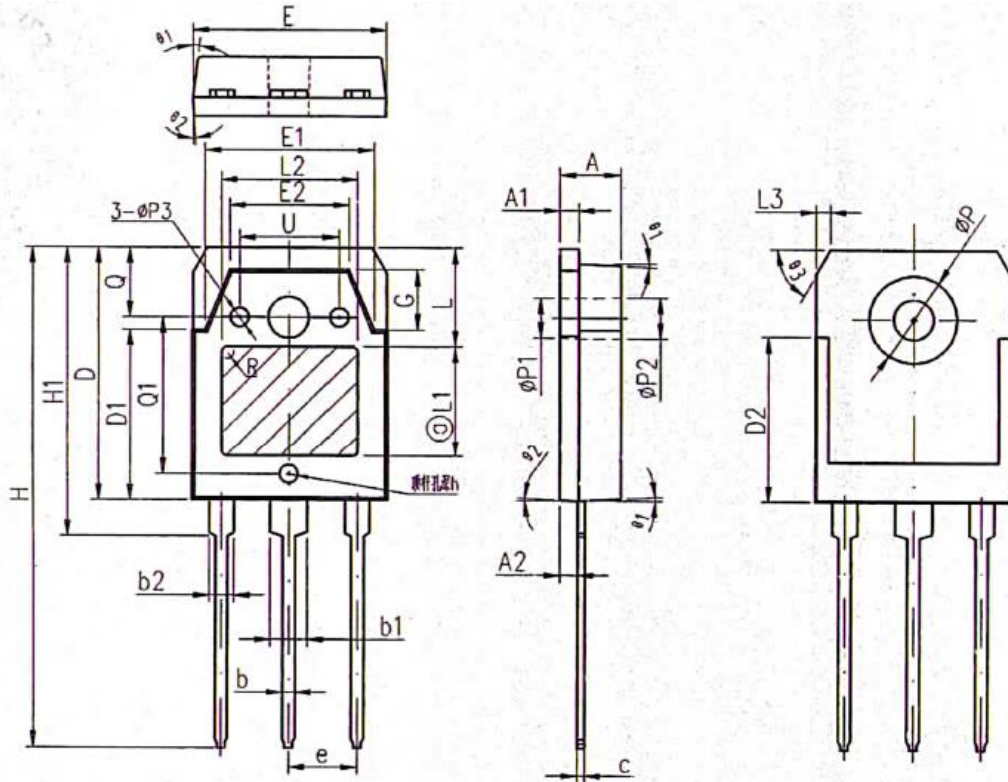
COMMON DIMENSIONS

SYMBOL	MM		
	MIN	NOM	MAX
E	10.00	10.16	10.32
E1	9.94	10.04	10.14
E2	9.36	9.46	9.56
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A4	2.66	2.76	2.86
A5	1.00REF		
c	0.45	0.50	0.60
D	15.67	15.87	16.07
Q	9.40REF		
H1	6.70REF		
e	2.54BSC		
$\Phi P$	3.18REF		
L	12.78	12.98	13.18
L1	2.83	2.93	3.03
L2	7.70	7.80	7.90
$\Phi P1$	1.40	1.50	1.60
$\Phi P2$	0.95	1.00	1.05
$\Phi P3$	3.45REF		
$\theta 1$	3°	5°	7°
$\theta 2$	-	45°	-
F1	1.00	1.50	2.00
F2	13.80	13.90	14.00
F3	3.20	3.30	3.40
F4	5.30	5.40	5.50
G	7.80	8.00	8.20
G1	6.90	7.00	7.10
G3	1.25	1.35	1.45
b1	1.23	1.28	1.38
b2	0.75	0.80	0.90
K1	0.65	0.70	0.75
R	0.50REF		



COMMON DIMENSIONS

SYMBOL	MM		
	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16	1.21	1.26
b2	1.96	2.01	2.06
b4	2.96	3.01	3.06
c	0.59	0.61	0.66
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.20	1.35
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	5.44BSC		
h	0.05	0.10	0.15
L	19.80	19.92	20.10
L1	-	-	4.30
$\Phi P$	3.50	3.60	3.70
$\Phi P1$	-	-	7.30
$\Phi P2$	2.40	2.50	2.60
Q	5.60	5.80	6.00
S	6.15BSC		
R	0.50REF		
T	9.80	-	10.20
T1	1.65REF		
T2	8.00REF		
T3	12.80REF		
U	6.00	-	6.40
$\theta 1$	6°	7°	8°
$\theta 2$	4°	5°	6°
$\theta 3$	1°	-	1.5°
$\theta 4$	14°	15°	16°



COMMON DIMENSIONS

SYMBOL	MM		
	MIN	NOM	MAX
A	4.60	4.80	5.00
A1	1.40	1.50	1.60
A2	1.33	1.38	1.43
b	0.80	1.00	1.20
b1	2.80	3.00	3.20
b2	1.80	2.00	2.20
c	0.50	0.60	0.70
D	19.75	19.90	20.05
D1	13.70	13.90	14.10
D2	12.90 REF		
E	15.40	15.60	15.80
E1	13.40	13.60	13.80
E2	9.40	9.60	9.80
e	5.45 TYP		
G	4.60	4.80	5.00
H	40.30	40.50	40.70
H1	23.20	23.40	23.60
h	0.05	0.10	0.15
L	7.40 TYP		
L1	9.00 TYP		
L2	11.00 TYP		
L3	1.00 REF		
$\phi P$	6.90	7.00	7.10
$\phi P1$	3.20 REF		
$\phi P2$	3.50 REF		
$\phi P3$	1.40	1.50	1.60
R	0.50 REF		
Q	5.00 REF		
Q1	12.56	12.76	12.96
U	7.8	8	8.2
$\theta 1$	5°	7°	9°
$\theta 2$	1°	3°	5°
$\theta 3$	60° REF		



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